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TID #: TIDA-01605	Project Title: Isolated SiC Gate Driver with Soft Turn-off Protection	Sheet: 2 of 3	
Number: TIDA-01605	Rev: E1	File: Gate_Driver_SchDoc	http://www.ti.com
SVN Rev: Version control disabled	Engineer: X.Gong	Contact: http://www.ti.com/support	© Texas Instruments 2018



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PCB Rev: E1

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Number: TIDA-01605	Rev: E1	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By: G.Wang	File: Gate_Driver_Hardware.SchDoc	Size: B	
Engineer: X.Gong	Contact: http://www.ti.com/support		

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